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**FACSIMILE TRANSMITTAL**

**DATE:** August 30, 2002

**TO:** U.S. Patent & Trademark Office  
Examining Group 2800

**FAX NO.:** 1-703-872-9318

**FROM:** Steven M. Jensen

**FAX NO.:** 617-439-4170

**Our Docket No.:** 55832 (71987)

**No. of Pages (incl. cover):** 14

**Re:** U.S. Serial Number 09/838,521

**MESSAGE:**

Please enter the attached Amendment.

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Docket No. 55832 (71987)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: C. Huang et al.  
U.S.S.N.: 09/838,521 GROUP: 2827  
FILED: April 19, 2001 EXAMINER: J. Mitchell  
FOR: METHOD OF FABRICATING A GROUND-BALL BONDING  
STRUCTURE WITHOUT TRAPPED AIR FOR TAPE BALL GRID  
ARRAY APPLICATION

CERTIFICATE OF FACSIMILE TRANSMISSION

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By:

Steven M. Jensen

Assistant Commissioner for Patents  
Washington, D.C. 20231

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Sir:

AMENDMENT

Applicants are in receipt of the Office Action dated May 30, 2002 of the above-referenced application. Please amend the application as follows:

IN THE SPECIFICATION

Please amend the paragraph on page 1, lines 14-17 as follows:

a' TBGA (Tape Ball Grid Array) is an improved type of BGA technology which is characterized by the use of a tape as the base for the mounting of a semiconductor chip and the attachment of solder balls thereon. The TBGA technology allows the overall package body to be made more compact in size.